

Certificate of Compliance

Certificate Number:

E479892

Report Reference:

E479892-20240205

Issue Date:

2024-02-05

Issued to:

**Shenzhen Jia Li Chuang Technology Development Co LTD
27F Olympic building Commercial daily Rd 2 Futian district
Shenzhen Guangdong Sheng 518000 China**

This certificate confirms that representative samples of:

WIRING, PRINTED - COMPONENT

See Addendum Page for Product Designation(s).

Have been evaluated by UL in accordance with the component requirements in the Standard(s) indicated on this Certificate. UL Recognized components are incomplete in certain constructional features or restricted in performance capabilities and are intended for installation in complete equipment submitted for investigation to UL LLC.

**UL 796, Printed Wiring Boards
CSA C22.2 No. 0.17, Evaluation of Properties of Polymeric
Materials**

Additional Information:

See UL Product iQ® at <https://iq.ulprospector.com> for additional information.

This Certificate of Compliance indicates that representative samples of the product described in the certification report have met the requirements for UL certification. It does not provide authorization to apply the UL Recognized Component Mark. Only the Authorization Page that references the Follow-Up Services Procedure for ongoing surveillance provides authorization to apply the UL Mark.

Only those products bearing the UL Recognized Component Mark should be considered as being UL Certified and covered under UL's Follow-Up Services.

Look for the UL Recognized Component Mark on the product.



David Piecuch

UL Mark Certification Program Manager



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CERTIFICATE OF COMPLIANCE

Certificate number E479892
Report reference E479892-20240205
Date 2024-02-05

This is to certify that representative samples of the product as specified on this certificate were tested according to the current UL requirements.

Multilayer printed wiring board, Type Designations: JLC-4

Notes:

ASP 1 - Assembly solder process evaluated to IPC-TM-650, 2.6.27 Thermal Stress Assembly Simulation



David Piecuch
UL Mark Certification Program Manager

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